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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	eZ8
Core Size	8-Bit
Speed	5MHz
Connectivity	IrDA, UART/USART
Peripherals	Brown-out Detect/Reset, LED, POR, PWM, WDT
Number of I/O	16
Program Memory Size	1KB (1K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f0113hh005sc

- 2.7 V to 3.6 V operating voltage
- Up to thirteen 5 V-tolerant input pins
- 8-, 20-, and 28-pin packages
- 0 °C to +70 °C and -40 °C to +105 °C for operating temperature ranges

Part Selection Guide

Table 1 lists the basic features and package styles available for each device within the Z8 Encore! XP® F0823 Series product line.

Table 1. Z8 Encore! XP F0823 Series Family Part Selection Guide

Part Number	Flash (KB)	RAM (B)	I/O	ADC Inputs	Packages
Z8F0823	8	1024	6–22	4–8	8-, 20-, and 28-pins
Z8F0813	8	1024	6–24	0	8-, 20-, and 28-pins
Z8F0423	4	1024	6–22	4–8	8-, 20-, and 28-pins
Z8F0413	4	1024	6–24	0	8-, 20-, and 28-pins
Z8F0223	2	512	6–22	4–8	8-, 20-, and 28-pins
Z8F0213	2	512	6–24	0	8-, 20-, and 28-pins
Z8F0123	1	256	6–22	4–8	8-, 20-, and 28-pins
Z8F0113	1	256	6–24	0	8-, 20-, and 28-pins

Table 6. Z8 Encore! XP F0823 Series Program Memory Maps (Continued)

Program Memory Address (Hex)	Function
0002–0003	Reset Vector
0004–0005	WDT Interrupt Vector
0006–0007	Illegal Instruction Trap
0008–0037	Interrupt Vectors*
0038–003D	Oscillator Fail Traps*
003E–03FF	Program Memory

*See Table 33 on page 54 for a list of the interrupt vectors and traps.

Data Memory

Z8 Encore! XP® F0823 Series does not use the eZ8 CPU's 64 KB Data Memory address space.

Flash Information Area

Table 7 lists the Z8 Encore! XP F0823 Series Flash Information Area. This 128 B Information Area is accessed by setting bit 7 of the Flash Page Select Register to 1. When access is enabled, the Flash Information Area is mapped into the Program Memory and overlays the 128 bytes at addresses FE00H to FF7FH. When the Information Area access is enabled, all reads from these Program Memory addresses return the Information Area data rather than the Program Memory data. Access to the Flash Information Area is read-only.

Table 7. Z8 Encore! XP F0823 Series Flash Memory Information Area Map

Program Memory Address (Hex)	Function
FE00–FE3F	Zilog Option Bits.
FE40–FE53	Part Number. 20-character ASCII alphanumeric code Left justified and filled with FH.
FE54–FE5F	Reserved.
FE60–FE7F	Zilog Calibration Data.
FE80–FFFF	Reserved.

Table 8. Register File Address Map (Continued)

Address (Hex)	Register Description	Mnemonic	Reset (Hex)	Page No
F0C	Timer 1 PWM High Byte	T1PWMH	00	81
F0D	Timer 1 PWM Low Byte	T1PWML	00	82
F0E	Timer 1 Control 0	T1CTL0	00	82
F0F	Timer 1 Control 1	T1CTL1	00	80
F10–F3F	Reserved	—	XX	
UART				
F40	UART0 Transmit Data	U0TXD	XX	104
	UART0 Receive Data	U0RXD	XX	105
F41	UART0 Status 0	U0STAT0	0000011Xb	105
F42	UART0 Control 0	U0CTL0	00	107
F43	UART0 Control 1	U0CTL1	00	107
F44	UART0 Status 1	U0STAT1	00	106
F45	UART0 Address Compare	U0ADDR	00	109
F46	UART0 Baud Rate High Byte	U0BRH	FF	110
F47	UART0 Baud Rate Low Byte	U0BRL	FF	110
F48–F6F	Reserved	—	XX	
Analog-to-Digital Converter (ADC)				
F70	ADC Control 0	ADCCTL0	00	122
F71	ADC Control 1	ADCCTL1	80	122
F72	ADC Data High Byte	ADCD_H	XX	124
F73	ADC Data Low Bits	ADCD_L	XX	124
F74–F7F	Reserved	—	XX	
Low Power Control				
F80	Power Control 0	PWRCTL0	80	33
F81	Reserved	—	XX	
LED Controller				
F82	LED Drive Enable	LEDEN	00	51
F83	LED Drive Level High Byte	LEDLVLH	00	51
F84	LED Drive Level Low Byte	LEDLVLL	00	52
F85	Reserved	—	XX	
Oscillator Control				
F86	Oscillator Control	OSCCTL	A0	167
F87–F8F	Reserved	—	XX	
Comparator 0				
F90	Comparator 0 Control	CMP0	14	128

Table 30. LED Drive Enable (LEDEN)

BITS	7	6	5	4	3	2	1	0
FIELD	LEDEN[7:0]							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	F82H							

LEDEN[7:0]—LED Drive Enable
These bits determine which Port C pins are connected to an internal current sink.
0 = Tristate the Port C pin.
1= Connect controlled current sink to the Port C pin.

LED Drive Level High Register

The LED Drive Level registers contain two control bits for each Port C pin (Table 31). These two bits select between four programmable drive levels. Each pin is individually programmable.

Table 31. LED Drive Level High Register (LEDLVLH)

BITS	7	6	5	4	3	2	1	0
FIELD	LEDLVLH[7:0]							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	F83H							

LEDLVLH[7:0]—LED Level High Bit
{LEDLVLH, LEDLVLL} select one of four programmable current drive levels for each Port C pin.
00 = 3 mA
01= 7 mA
10= 13 mA
11= 20 mA

LED Drive Level Low Register

The LED Drive Level registers contain two control bits for each Port C pin (Table 32). These two bits select between four programmable drive levels. Each pin is individually programmable.

0x = Timer Interrupt occurs on all defined Reload, Compare and Input Events
10 = Timer Interrupt only on defined Input Capture/Deassertion Events
11 = Timer Interrupt only on defined Reload/Compare Events

Reserved—Must be 0

PWMD—PWM Delay value
This field is a programmable delay to control the number of system clock cycles delay before the Timer Output and the Timer Output Complement are forced to their active state.

000 = No delay
001 = 2 cycles delay
010 = 4 cycles delay
011 = 8 cycles delay
100 = 16 cycles delay
101 = 32 cycles delay
110 = 64 cycles delay
111 = 128 cycles delay

INPCAP—Input Capture Event
This bit indicates if the most recent timer interrupt is caused by a Timer Input Capture Event.

0 = Previous timer interrupt is not a result of Timer Input Capture Event
1 = Previous timer interrupt is a result of Timer Input Capture Event

Timer 0–1 Control Register 1

The Timer 0–1 Control (TxCTL1) registers enable/disable the timers, set the prescaler value, and determine the timer operating mode.

Table 56. Timer 0–1 Control Register 1 (TxCTL1)

BITS	7	6	5	4	3	2	1	0
FIELD	TEN	TPOL	PRES			TMODE		
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	F07H, F0FH							

TEN—Timer Enable
0 = Timer is disabled
1 = Timer enabled to count

TPOL—Timer Input/Output Polarity
Operation of this bit is a function of the current operating mode of the timer

Watchdog Timer Reload Byte registers (WDTU, WDTH, and WDTL) to allow changes to the time-out period. These write operations to the WDTCTL register address produce no effect on the bits in the WDTCTL register. The locking mechanism prevents spurious writes to the Reload registers.

This register address is shared with the read-only Reset Status Register.

Table 58. Watchdog Timer Control Register (WDTCTL)

BITS	7	6	5	4	3	2	1	0
FIELD	WDTUNLK							
RESET	X	X	X	X	X	X	X	X
R/W	W	W	W	W	W	W	W	W
ADDR	FF0H							

WDTUNLK—Watchdog Timer Unlock
The software must write the correct unlocking sequence to this register before it is allowed to modify the contents of the Watchdog Timer reload registers.

Watchdog Timer Reload Upper, High and Low Byte Registers

The Watchdog Timer Reload Upper, High and Low Byte (WDTU, WDTH, WDTL) registers (Tables 59 through Table 61) form the 24-bit reload value that is loaded into the Watchdog Timer when a `WDT` instruction executes. The 24-bit reload value is {WDTU[7:0], WDTH[7:0], WDTL[7:0]}. Writing to these registers sets the appropriate Reload Value. Reading from these registers returns the current Watchdog Timer count value.

! **Caution:** *The 24-bit WDT Reload Value must not be set to a value less than* `000004H`.

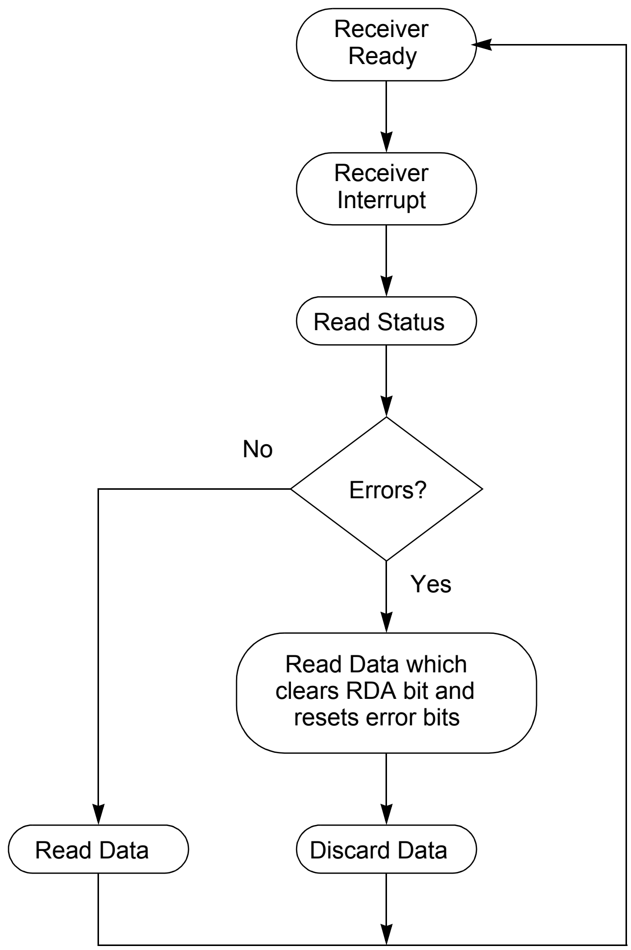

Figure 15. UART Receiver Interrupt Service Routine Flow

Baud Rate Generator Interrupts

If the Baud Rate Generator (BRG) interrupt enable is set, the UART Receiver interrupt asserts when the UART Baud Rate Generator reloads. This condition allows the Baud Rate Generator to function as an additional counter if the UART functionality is not employed.

UART Baud Rate Generator

The UART Baud Rate Generator creates a lower frequency baud rate clock for data transmission. The input to the Baud Rate Generator is the system clock. The UART Baud Rate High and Low Byte registers combine to create a 16-bit baud rate divisor value

(BRG[15:0]) that sets the data transmission rate (baud rate) of the UART. The UART data rate is calculated using the following equation:

$$\text{UART Data Rate (bits/s)} = \frac{\text{System Clock Frequency (Hz)}}{16 \times \text{UART Baud Rate Divisor Value}}$$

When the UART is disabled, the Baud Rate Generator functions as a basic 16-bit timer with interrupt on time-out. Follow the steps below to configure the Baud Rate Generator as a timer with interrupt on time-out:

1. Disable the UART by clearing the REN and TEN bits in the UART Control 0 register to 0.
2. Load the acceptable 16-bit count value into the UART Baud Rate High and Low Byte registers.
3. Enable the Baud Rate Generator timer function and associated interrupt by setting the BIRQ bit in the UART Control 1 register to 1.

When configured as a general purpose timer, the interrupt interval is calculated using the following equation:

$$\text{Interrupt Interval (s)} = \text{System Clock Period (s)} \times \text{BRG[15:0]}$$

UART Control Register Definitions

The UART control registers support the UART and the associated Infrared Encoder/Decoders. For more information on the infrared operation, see Infrared Encoder/Decoder on page 113.

UART Transmit Data Register

Data bytes written to the UART Transmit Data register (Table 62) are shifted out on the TXDx pin. The Write-only UART Transmit Data register shares a Register File address with the read-only UART Receive Data register.

Table 62. UART Transmit Data Register (U0TXD)

BITS	7	6	5	4	3	2	1	0
FIELD	TXD							
RESET	X	X	X	X	X	X	X	X
R/W	W	W	W	W	W	W	W	W
ADDR	F40H							

TXD—Transmit Data
UART transmitter data byte to be shifted out through the TXD*x* pin.

Software Compensation Procedure

The value read from the ADC high and low byte registers are uncompensated. The user mode software must apply gain and offset correction to this uncompensated value for maximum accuracy. The following formula yields the compensated value:

$$ADC_{comp} = (ADC_{uncomp} - OFFCAL) + ((ADC_{uncomp} - OFFCAL)*GAINCAL)/2^{16}$$

where GAINCAL is the gain calibration byte, OFFCAL is the offset calibration byte and ADC_{uncomp} is the uncompensated value read from the ADC. The OFFCAL value is in two's complement format, as are the compensated and uncompensated ADC values.

Note: *The offset compensation is performed first, followed by the gain compensation. One bit of resolution is lost because of rounding on both the offset and gain computations. As a result the ADC registers read back 13 bits: 1 sign bit, two calibration bits lost to rounding and 10 data bits. Also note that in the second term, the multiplication must be performed before the division by 2^{16}. Otherwise, the second term evaluates to zero incorrectly.*

Caution: *Although the ADC can be used without the gain and offset compensation, it does exhibit non-unity gain. Designing the ADC with sub-unity gain reduces noise across the ADC range but requires the ADC results to be scaled by a factor of 8/7.*

ADC Control Register Definitions

The following sections define the ADC control registers.

ADC Control Register 0

The ADC Control register selects the analog input channel and initiates the analog-to-digital conversion.

Table 72. ADC Control Register 0 (ADCCTL0)

BITS	7	6	5	4	3	2	1	0
FIELD	CEN	REFSELL	REFEXT	CONT	ANAIN[3:0]			
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	F70H							

CEN—Conversion Enable
0 = Conversion is complete. Writing a 0 produces no effect. The ADC automatically clears this bit to 0 when a conversion is complete.
1 = Begin conversion. Writing a 1 to this bit starts a conversion. If a conversion is already in progress, the conversion restarts. This bit remains 1 until the conversion is complete.

Figure 20. Flash Memory Arrangement

Flash Information Area

The Flash information area is separate from program memory and is mapped to the address range `FE00H` to `FFFFH`. Not all these addresses are accessible. Factory trim values for the analog peripherals are stored here. Factory calibration data for the ADC is also stored here.

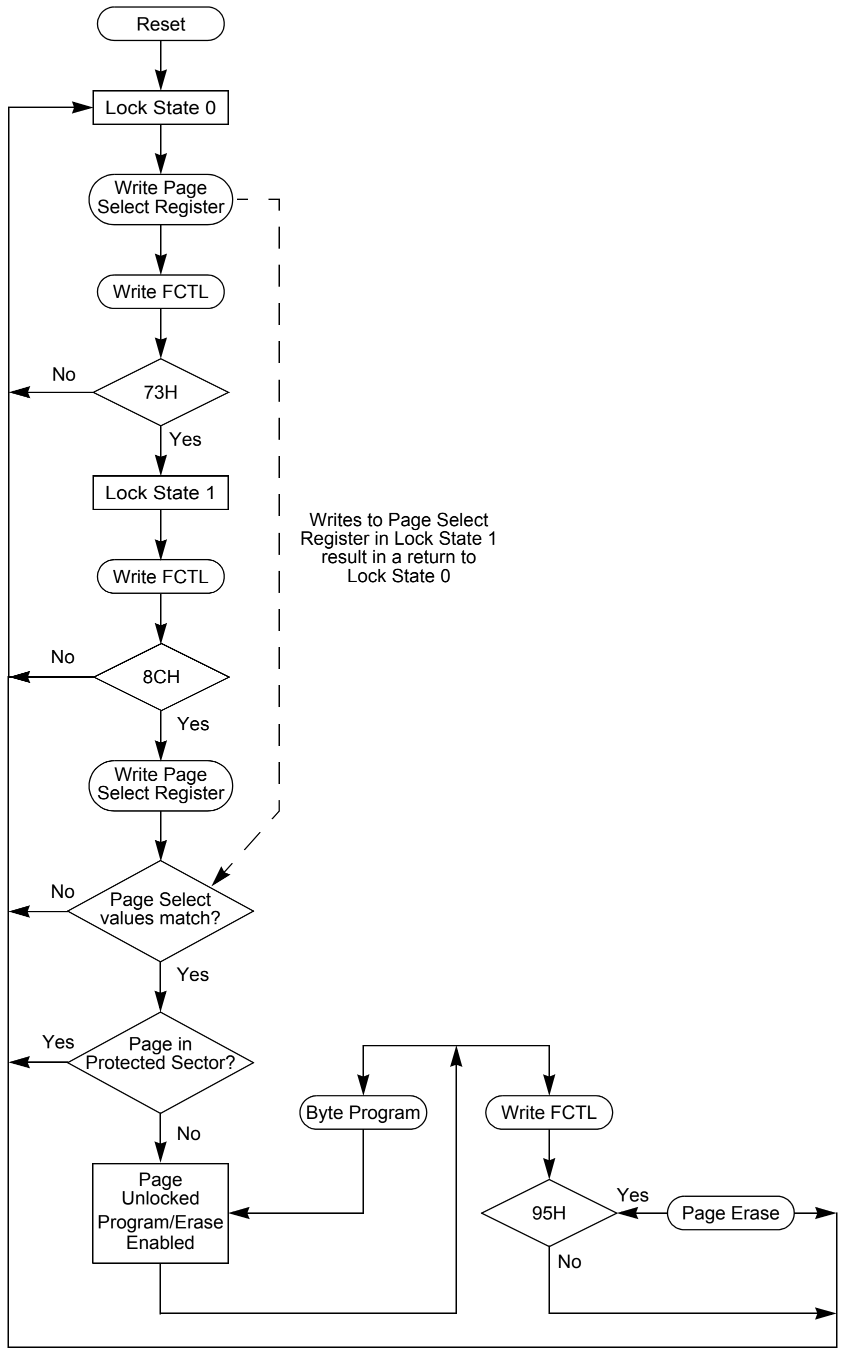

Figure 21. Flash Controller Operation Flowchart

Flash Control Register Definitions

Flash Control Register

The Flash Controller must be unlocked using the Flash Control (FTCTL) register before programming or erasing the Flash memory. Writing the sequence 73H 8CH, sequentially, to the Flash Control register unlocks the Flash Controller. When the Flash Controller is unlocked, the Flash memory can be enabled for Mass Erase or Page Erase by writing the appropriate enable command to the FCTL. Page Erase applies only to the active page selected in Flash Page Select register. Mass Erase is enabled only through the On-Chip Debugger. Writing an invalid value or an invalid sequence returns the Flash Controller to its locked state. The Write-only Flash Control Register shares its Register File address with the read-only Flash Status Register.

Table 79. Flash Control Register (FCTL)

BITS	7	6	5	4	3	2	1	0
FIELD	FCMD							
RESET	0	0	0	0	0	0	0	0
R/W	W	W	W	W	W	W	W	W
ADDR	FF8H							

FCMD—Flash Command
73H = First unlock command
8CH = Second unlock command

95H = Page Erase command (must be third command in sequence to initiate Page Erase)
63H = Mass Erase command (must be third command in sequence to initiate Mass Erase)

5EH = Enable Flash Sector Protect Register Access

Flash Status Register

The Flash Status register indicates the current state of the Flash Controller. This register can be read at any time. The read-only Flash Status Register shares its Register File address with the write-only Flash Control Register.

Table 80. Flash Status Register (FSTAT)

BITS	7	6	5	4	3	2	1	0
FIELD	Reserved		FSTAT					
RESET	0	0	0	0	0	0	0	0
R/W	R	R	R	R	R	R	R	R
ADDR	FF8H							

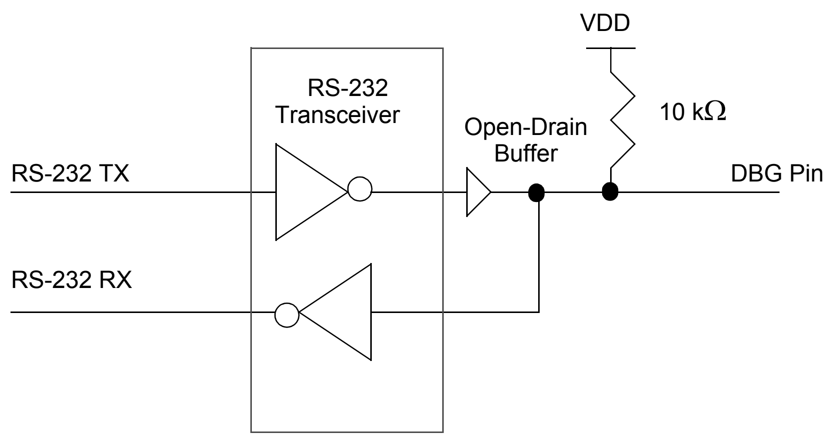

Figure 24. Interfacing the On-Chip Debugger's DBG Pin with an RS-232 Interface (2)

DEBUG Mode

The operating characteristics of the devices in DEBUG mode are:

- The eZ8 CPU fetch unit stops, idling the eZ8 CPU, unless directed by the OCD to execute specific instructions
- The system clock operates unless in STOP mode
- All enabled on-chip peripherals operate unless in STOP mode
- Automatically exits HALT mode
- Constantly refreshes the Watchdog Timer, if enabled.

Entering DEBUG Mode

The device enters DEBUG mode following the operations below:

- The device enters DEBUG mode after the eZ8 CPU executes a BRK (breakpoint) instruction
- If the DBG pin is held Low during the most recent clock cycle of System Reset, the part enters DEBUG mode upon exiting System Reset

Note: *Holding the DBG pin Low for an additional 5000 (minimum) clock cycles after reset (making sure to account for any specified frequency error if using an internal oscillator) prevents a false interpretation of an Autobaud sequence (see* OCD Auto-Baud Detector/ Generator *on page 154).*

- If the PA2/$\overline{\text{RESET}}$ pin is held Low while a 32-bit key sequence is issued to the PA0/DBG pin, the DBG feature is unlocked. After releasing PA2/$\overline{\text{RESET}}$, it is pulled high. At this is not in DEBUG mode or if the Flash Read Protect Option bit is enabled, the data is discarded.

```
DBG ← 0AH
DBG ← Program Memory Address[15:8]
DBG ← Program Memory Address[7:0]
DBG ← Size[15:8]
DBG ← Size[7:0]
DBG ← 1-65536 data bytes
```

- **Read Program Memory (0BH)**—The Read Program Memory command reads data from Program Memory. This command is equivalent to the `LDC` and `LDCI` instructions. Data can be read 1–65536 bytes at a time (65536 bytes can be read by setting size to 0). If the device is not in DEBUG mode or if the Flash Read Protect Option Bit is enabled, this command returns `FFH` for the data.

```
DBG ← 0BH
DBG ← Program Memory Address[15:8]
DBG ← Program Memory Address[7:0]
DBG ← Size[15:8]
DBG ← Size[7:0]
DBG → 1-65536 data bytes
```

- **Write Data Memory (0CH)**—The Write Data Memory command writes data to Data Memory. This command is equivalent to the `LDE` and `LDEI` instructions. Data can be written 1–65536 bytes at a time (65536 bytes can be written by setting size to 0). If the device is not in DEBUG mode or if the Flash Read Protect Option Bit is enabled, the data is discarded.

```
DBG ← 0CH
DBG ← Data Memory Address[15:8]
DBG ← Data Memory Address[7:0]
DBG ← Size[15:8]
DBG ← Size[7:0]
DBG ← 1-65536 data bytes
```

- **Read Data Memory (0DH)**—The Read Data Memory command reads from Data Memory. This command is equivalent to the `LDE` and `LDEI` instructions. Data can be read 1 to 65536 bytes at a time (65536 bytes can be read by setting size to 0). If the device is not in DEBUG mode, this command returns `FFH` for the data.

```
DBG ← 0DH
DBG ← Data Memory Address[15:8]
DBG ← Data Memory Address[7:0]
DBG ← Size[15:8]
DBG ← Size[7:0]
DBG → 1-65536 data bytes
```

Table 106 lists additional symbols that are used throughout the Instruction Summary and Instruction Set Description sections.

Table 106. Additional Symbols

Symbol	Definition
dst	Destination Operand
src	Source Operand
@	Indirect Address Prefix
SP	Stack Pointer
PC	Program Counter
FLAGS	Flags Register
RP	Register Pointer
#	Immediate Operand Prefix
B	Binary Number Suffix
%	Hexadecimal Number Prefix
H	Hexadecimal Number Suffix

Assignment of a value is indicated by an arrow. For example,

dst ← dst + src

indicates the source data is added to the destination data and the result is stored in the destination location.

eZ8 CPU Instruction Classes

eZ8 CPU instructions are divided functionally into the following groups:

- Arithmetic
- Bit Manipulation
- Block Transfer
- CPU Control
- Load
- Logical
- Program Control

Ordering Information

Part Number	Flash	RAM	I/O Lines	Interrupts	16-Bit Timers w/PWM	10-Bit A/D Channels	UART with IrDA	Description
Z8 Encore! XP with 8 KB Flash, 10-Bit Analog-to-Digital Converter								
Standard Temperature: 0 °C to 70 °C								
Z8F0823PB005SC	8 KB	1 KB	6	12	2	4	1	PDIP 8-pin package
Z8F0823QB005SC	8 KB	1 KB	6	12	2	4	1	QFN 8-pin package
Z8F0823SB005SC	8 KB	1 KB	6	12	2	4	1	SOIC 8-pin package
Z8F0823SH005SC	8 KB	1 KB	16	18	2	7	1	SOIC 20-pin package
Z8F0823HH005SC	8 KB	1 KB	16	18	2	7	1	SSOP 20-pin package
Z8F0823PH005SC	8 KB	1 KB	16	18	2	7	1	PDIP 20-pin package
Z8F0823SJ005SC	8 KB	1 KB	22	18	2	8	1	SOIC 28-pin package
Z8F0823HJ005SC	8 KB	1 KB	22	18	2	8	1	SSOP 28-pin package
Z8F0823PJ005SC	8 KB	1 KB	22	18	2	8	1	PDIP 28-pin package
Extended Temperature: -40 °C to 105 °C								
Z8F0823PB005EC	8 KB	1 KB	6	12	2	4	1	PDIP 8-pin package
Z8F0823QB005EC	8 KB	1 KB	6	12	2	4	1	QFN 8-pin package
Z8F0823SB005EC	8 KB	1 KB	6	12	2	4	1	SOIC 8-pin package
Z8F0823SH005EC	8 KB	1 KB	16	18	2	7	1	SOIC 20-pin package
Z8F0823HH005EC	8 KB	1 KB	16	18	2	7	1	SSOP 20-pin package
Z8F0823PH005EC	8 KB	1 KB	16	18	2	7	1	PDIP 20-pin package
Z8F0823SJ005EC	8 KB	1 KB	22	18	2	8	1	SOIC 28-pin package
Z8F0823HJ005EC	8 KB	1 KB	22	18	2	8	1	SSOP 28-pin package
Z8F0823PJ005EC	8 KB	1 KB	22	18	2	8	1	PDIP 28-pin package
Replace C with G for Lead-Free Packaging								

Part Number	Flash	RAM	I/O Lines	Interrupts	16-Bit Timers w/PWM	10-Bit A/D Channels	UART with IrDA	Description
Z8 Encore! XP with 2 KB Flash, 10-Bit Analog-to-Digital Converter								
Standard Temperature: 0 °C to 70 °C								
Z8F0223PB005SC	2 KB	512 B	6	12	2	4	1	PDIP 8-pin package
Z8F0223QB005SC	2 KB	512 B	6	12	2	4	1	QFN 8-pin package
Z8F0223SB005SC	2 KB	512 B	6	12	2	4	1	SOIC 8-pin package
Z8F0223SH005SC	2 KB	512 B	16	18	2	7	1	SOIC 20-pin package
Z8F0223HH005SC	2 KB	512 B	16	18	2	7	1	SSOP 20-pin package
Z8F0223PH005SC	2 KB	512 B	16	18	2	7	1	PDIP 20-pin package
Z8F0223SJ005SC	2 KB	512 B	22	18	2	8	1	SOIC 28-pin package
Z8F0223HJ005SC	2 KB	512 B	22	18	2	8	1	SSOP 28-pin package
Z8F0223PJ005SC	2 KB	512 B	22	18	2	8	1	PDIP 28-pin package
Extended Temperature: -40 °C to 105 °C								
Z8F0223PB005EC	2 KB	512 B	6	12	2	4	1	PDIP 8-pin package
Z8F0223QB005EC	2 KB	512 B	6	12	2	4	1	QFN 8-pin package
Z8F0223SB005EC	2 KB	512 B	6	12	2	4	1	SOIC 8-pin package
Z8F0223SH005EC	2 KB	512 B	16	18	2	7	1	SOIC 20-pin package
Z8F0223HH005EC	2 KB	512 B	16	18	2	7	1	SSOP 20-pin package
Z8F0223PH005EC	2 KB	512 B	16	18	2	7	1	PDIP 20-pin package
Z8F0223SJ005EC	2 KB	512 B	22	18	2	8	1	SOIC 28-pin package
Z8F0223HJ005EC	2 KB	512 B	22	18	2	8	1	SSOP 28-pin package
Z8F0223PJ005EC	2 KB	512 B	22	18	2	8	1	PDIP 28-pin package
Replace C with G for Lead-Free Packaging								

L

M

N

O

P

R